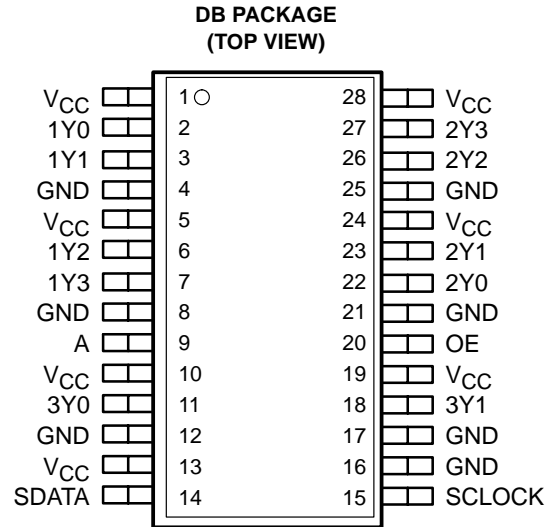


CDC319 1-LINE TO 10-LINE CLOCK DRIVER WITH I²C CONTROL INTERFACE

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- **High-Speed, Low-Skew 1-to-10 Clock Buffer for SDRAM (Synchronous DRAM) Clock Buffering Applications**
- **Output Skew, $t_{sk(o)}$, Less Than 250 ps**
- **Pulse Skew, $t_{sk(p)}$, Less Than 500 ps**
- **Supports up to Two Unbuffered SDRAM DIMMs (Dual Inline Memory Modules)**
- **I²C Serial Interface Provides Individual Enable Control for Each Output**
- **Operates at 3.3 V**
- **Distributed V_{CC} and Ground Pins Reduce Switching Noise**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015**
- **Packaged in 28-Pin Shrink Small Outline (DB) Package**



description

The CDC319 is a high-performance clock buffer that distributes one input (A) to 10 outputs (Y) with minimum skew for clock distribution. The CDC319 operates from a 3.3-V power supply, and is characterized for operation from 0°C to 70°C.

The device provides a standard mode (100K-bits/s) I²C serial interface for device control. The implementation is as a slave/receiver. The device address is specified in the I²C device address table. Both of the I²C inputs (SDATA and SCLOCK) provide integrated pullup resistors (typically 140 kΩ) and are 5-V tolerant.

Three 8-bit I²C registers provide individual enable control for each of the outputs. All outputs default to enabled at powerup. Each output can be placed in a disabled mode with a low-level output when a low-level control bit is written to the control register. The registers are write only and must be accessed in sequential order (i.e., random access of the registers is not supported).

The CDC319 provides 3-state outputs for testing and debugging purposes. The outputs can be placed in a high-impedance state via the output-enable (OE) input. When OE is high, all outputs are in the operational state. When OE is low, the outputs are placed in a high-impedance state. OE provides an integrated pullup resistor.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

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CDC319

1-LINE TO 10-LINE CLOCK DRIVER WITH I²C CONTROL INTERFACE

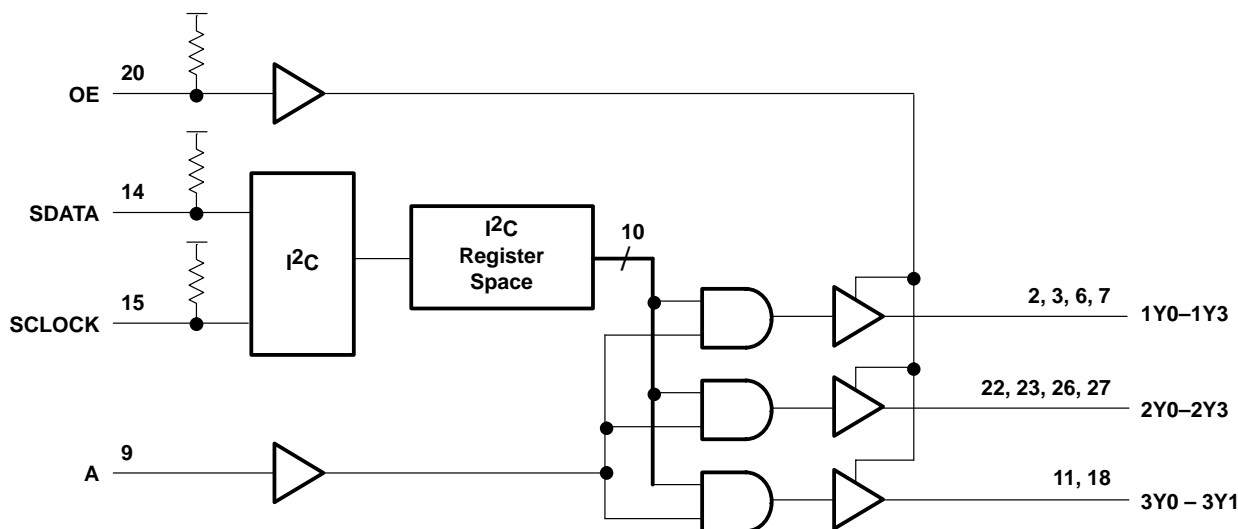
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FUNCTION TABLE

| INPUTS | | OUTPUTS | | |
|--------|---|----------------|----------------|----------------|
| OE | A | 1Y0–1Y3 | 2Y0–2Y3 | 3Y0–3Y1 |
| L | X | Hi-Z | Hi-Z | Hi-Z |
| H | L | L | L | L |
| H | H | H [†] | H [†] | H [†] |

[†]The function table assumes that all outputs are enabled via the appropriate I²C configuration register bit. If the output is disabled via the appropriate configuration bit, then the output is driven to a low state, regardless of the state of the A input.

logic diagram (positive logic)



Terminal Functions

| NAME | TERMINAL NO. | I/O | DESCRIPTION |
|---------|--------------------------|-----|---|
| 1Y0–1Y3 | 2, 3, 6, 7 | O | 3.3-V SDRAM byte 0 clock outputs |
| 2Y0–2Y3 | 22, 23, 26, 27 | O | 3.3-V SDRAM byte 1 clock outputs |
| 3Y0–3Y1 | 11, 18 | O | 3.3-V clock outputs provided for feedback control of external PLLs (phase-locked loops) |
| A | 9 | I | Clock input |
| OE | 20 | I | Output enable. When asserted, OE puts all outputs in a high-impedance state. A nominal 140-kΩ pullup resistor is internally integrated. |
| SCLOCK | 15 | I | I ² C serial clock input. A nominal 140-kΩ pullup resistor is internally integrated. |
| SDATA | 14 | I/O | Bidirectional I ² C serial data input/output. A nominal 140-kΩ pullup resistor is internally integrated. |
| GND | 4, 8, 12, 16, 17, 21, 25 | | Ground |
| VCC | 1, 5, 10, 13, 19, 24, 28 | | 3.3-V power supply |



I²C DEVICE ADDRESS

| A7 | A6 | A5 | A4 | A3 | A2 | A1 | A0 (R/W) |
|----|----|----|----|----|----|----|----------|
| H | H | L | H | L | L | H | — |

I²C BYTE 0-BIT DEFINITION†

| BIT | DEFINITION | DEFAULT VALUE |
|-----|--------------------|---------------|
| 7 | Reserved | H |
| 6 | Reserved | H |
| 5 | Reserved | H |
| 4 | Reserved | H |
| 3 | 1Y3 enable (pin 7) | H |
| 2 | 1Y2 enable (pin 6) | H |
| 1 | 1Y1 enable (pin 3) | H |
| 0 | 1Y0 enable (pin 2) | H |

† When the value of the bit is high, the output is enabled.
 When the value of the bit is low, the output is forced to a low state. The default value of all bits is high.

I²C BYTE 1-BIT DEFINITION†

| BIT | DEFINITION | DEFAULT VALUE |
|-----|---------------------|---------------|
| 7 | 2Y3 enable (pin 27) | H |
| 6 | 2Y2 enable (pin 26) | H |
| 5 | 2Y1 enable (pin 23) | H |
| 4 | 2Y0 enable (pin 22) | H |
| 3 | Reserved | H |
| 2 | Reserved | H |
| 1 | Reserved | H |
| 0 | Reserved | H |

† When the value of the bit is high, the output is enabled.
 When the value of the bit is low, the output is forced to a low state. The default value of all bits is high.

I²C BYTE 2-BIT DEFINITION†

| BIT | DEFINITION | DEFAULT VALUE |
|-----|---------------------|---------------|
| 7 | 3Y1 enable (pin 18) | H |
| 6 | 3Y0 enable (pin 11) | H |
| 5 | Reserved | H |
| 4 | Reserved | H |
| 3 | Reserved | H |
| 2 | Reserved | H |
| 1 | Reserved | H |
| 0 | Reserved | H |

† When the value of the bit is high, the output is enabled.
 When the value of the bit is low, the output is forced to a low state. The default value of all bits is high.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|---|----------------------------|
| Supply voltage range, V_{CC} | –0.5 V to 4.6 V |
| Input voltage range, V_I (see Note 1) | –0.5 V to 4.6 V |
| Input voltage range, V_I (SCLOCK, SDATA) (see Note 1) | –0.5 V to 6.5 V |
| Output voltage range, V_O (SDATA) (see Note 1) | –0.5 V to 6.5 V |
| Voltage range applied to any output in the high-impedance or power-off state, V_O | –0.5 V to $V_{CC} + 0.5$ V |
| Current into any output in the low state (except SDATA), I_O | 48 mA |
| Current into SDATA in the low state, I_O | 12 mA |
| Input clamp current, I_{IK} ($V_I < 0$) (SCLOCK) | –50 mA |
| Output clamp current, I_{OK} ($V_O < 0$) (SDATA) | –50 mA |
| Package thermal impedance, θ_{JA} (see Note 2) | 120 °C/W |
| Storage temperature range, T_{stg} | –65°C to 150°C |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds | 260°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51, except for through-hole packages, which use a trace length of zero.

recommended operating conditions (see Note 3)

| | | MIN | TYP | MAX | UNIT |
|-----------------|--------------------------------|----------------------------|------|--------------|------------|
| V_{CC} | 3.3-V core supply voltage | 3.135 | | 3.465 | V |
| V_{IH} | High-level input voltage | A, OE | 2 | $V_{CC}+0.3$ | V |
| | | SDATA, SCLOCK (see Note 3) | 2.2 | 5.5 | V |
| V_{IL} | Low-level input voltage | A, OE | –0.3 | 0.8 | V |
| | | SDATA, SCLOCK (see Note 3) | 0 | 1.04 | V |
| I_{OH} | High-level output current | | | –24 | mA |
| I_{OL} | Low-level output current | | | 24 | mA |
| R_I | Input resistance to V_{CC} | | 140 | | k Ω |
| $f(SCL)$ | SCLOCK frequency | | | 100 | kHz |
| $t(BUS)$ | Bus free time | 4.7 | | | μ s |
| $t_{su}(START)$ | START setup time | 4.7 | | | μ s |
| $t_h(START)$ | START hold time | 4 | | | μ s |
| $t_w(SCLL)$ | SCLOCK low pulse duration | 4.7 | | | μ s |
| $t_w(SCLH)$ | SCLOCK high pulse duration | 4 | | | μ s |
| $t_r(SDATA)$ | SDATA input rise time | | | 1000 | ns |
| $t_f(SDATA)$ | SDATA input fall time | | | 300 | ns |
| $t_{su}(SDATA)$ | SDATA setup time | 250 | | | ns |
| $t_h(SDATA)$ | SDATA hold time | 0 | | | ns |
| $t_{su}(STOP)$ | STOP setup time | 4 | | | μ s |
| T_A | Operating free-air temperature | 0 | | 70 | °C |

NOTE 3: The CMOS-level inputs fall within these limits: $V_{IH} \text{ min} = 0.7 \times V_{CC}$ and $V_{IL} \text{ max} = 0.3 \times V_{CC}$.



electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------|-------------------------------------|---------------|--|------------------------|-----|------|------|
| V _{IK} | Input clamp voltage | | V _{CC} = 3.135 V, I _I = -18 mA | | | -1.2 | V |
| V _{OH} | High-level output voltage | Y outputs | V _{CC} = 3.135 V, I _{OH} = -1 mA | 2.4 | | | V |
| V _{OL} | Low-level output voltage | Y outputs | V _{CC} = 3.135 V, I _{OL} = 1 mA | | | 0.4 | V |
| | | SDATA | V _{CC} = 3.135 V | I _{OL} = 3 mA | 0.1 | 0.4 | |
| | | | | I _{OL} = 6 mA | 0.2 | 0.6 | |
| I _{OH} | High-level output current | SDATA | V _{CC} = 3.135 V, V _O = V _{CC} MAX | | | 20 | μA |
| | | Y outputs | V _{CC} = 3.135 V, V _O = 2 V | -54 | | -126 | mA |
| | | | V _{CC} = 3.3 V, V _O = 2.6 V | | -60 | | |
| I _{OL} | Low-level output current | Y outputs | V _{CC} = 3.135 V, V _O = 1 V | 49 | | 118 | mA |
| | | | V _{CC} = 3.3 V, V _O = 0.7 V | | 58 | | |
| | | | V _{CC} = 3.465 V, V _O = 0.4 V | 23 | | 53 | |
| I _{IH} | High-level input current | A | V _{CC} = 3.465 V, V _I = V _{CC} | | | 5 | μA |
| | | OE | | 20 | | | |
| | | SCLOCK, SDATA | | 20 | | | |
| I _{IL} | Low-level input current | A | V _{CC} = 3.465 V, V _I = GND | | | -5 | μA |
| | | OE | | -10 | -50 | | |
| | | SCLOCK, SDATA | | -10 | -50 | | |
| I _{OZ} | High-impedance-state output current | | V _{CC} = 3.465 V, V _O = 3.465 V or 0 | | | ±10 | μA |
| I _{off} | Off-state current | SCLOCK, SDATA | V _{CC} = 0 V, V _I = 0 V to 5.5 V | | | 50 | μA |
| I _{CC} | Supply current | | V _{CC} = 3.465 V, I _O = 0 | | 0.2 | 0.5 | mA |
| ΔI _{CC} | Change in supply current | | V _{CC} = 3.135 V to 3.465 V, One input at V _{CC} - 0.6 V, All other inputs at V _{CC} or GND | | | 500 | μA |
| C _i | Input capacitance | | V _I = V _{CC} or GND, V _{CC} = 3.3 V | | 4 | | pF |
| C _o | Output capacitance | | V _O = V _{CC} or GND, V _{CC} = 3.3 V | | 6 | | pF |
| C _{I/O} | SDATA I/O capacitance | | V _{I/O} = V _{CC} or GND, V _{CC} = 3.3 V | | 7 | | pF |

CDC319

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switching characteristics over recommended operating conditions

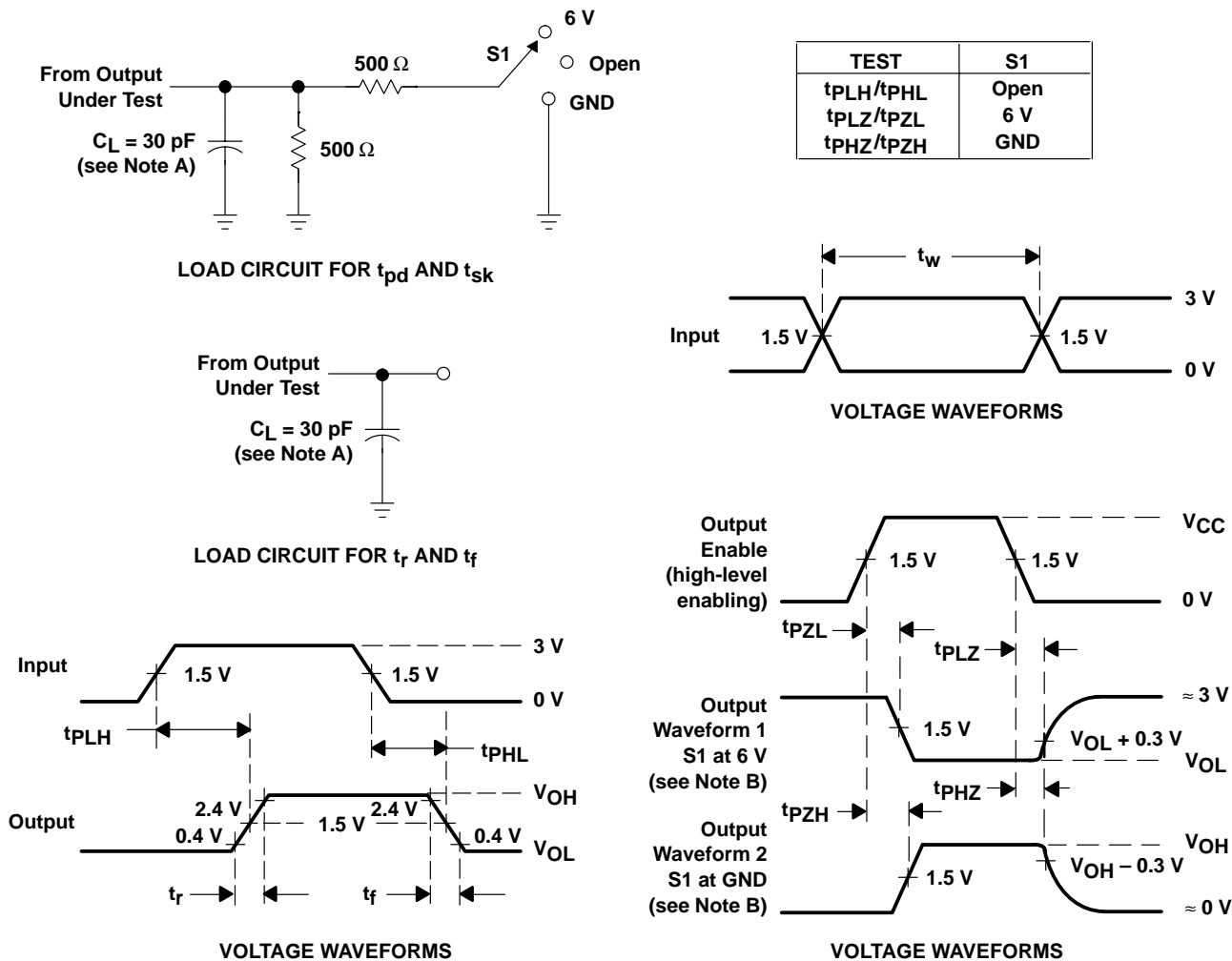
| PARAMETER | | FROM | TO | TEST CONDITIONS | MIN | MAX | UNIT |
|---------------------|--|---------|-------------|--|-----|-----|------|
| t _{PLH} | Low-to-high level propagation delay time | A | Y | | 1.2 | 3.6 | ns |
| | | SCLOCK↓ | SDATA valid | V _{CC} = 3.3 V ±0.185 V, See Figure 3 | | 2 | μs |
| t _{PLH} | Low-to-high level propagation delay time | SDATA↑ | Y | V _{CC} = 3.3 V ±0.185 V, See Figure 3 | | 150 | ns |
| t _{PHL} | High-to-low level propagation delay time | A | Y | | 1.2 | 3.6 | ns |
| | | SCLOCK↓ | SDATA valid | V _{CC} = 3.3 V ±0.185 V, See Figure 3 | | 2 | μs |
| t _{PHL} | High-to-low level propagation delay time | SDATA↑ | Y | V _{CC} = 3.3 V ±0.185 V, See Figure 3 | | 150 | ns |
| t _{PZH} | Enable time to the high level | OE | Y | | 1 | 4.7 | ns |
| t _{PZL} | Enable time to the low level | | | | | | |
| t _{PHZ} | Disable time from the high level | | | | | | |
| t _{PLZ} | Disable time from the low level | | | | | | |
| t _{sk(o)} | Skew time | A | Y | | | 250 | ps |
| t _{sk(p)} | Skew time | A | Y | | | 500 | ps |
| t _{sk(pr)} | Skew time | A | Y | | | 1 | ns |
| t _r | Rise time | | Y | | 0.5 | 1.3 | ns |
| t _r | Rise time (see Note 4 and Figure 3) | SDATA | | C _L = 10 pF | 6 | | ns |
| | | | | C _L = 400 pF | | 250 | |
| t _f | Fall time | | Y | | 0.5 | 1.3 | ns |
| t _f | Fall time (see Note 4 and Figure 3) | SDATA | | C _L = 10 pF | 20 | | ns |
| | | | | C _L = 400 pF | | 250 | |
| f | Operating frequency (see Note 5) | | | C _L = 30 pF, T _A = 70°C | | 100 | MHz |
| | | | | C _L = 20 pF, T _A = 70°C | | 125 | |
| | | | | C _L = 15 pF, T _A = 70°C | | 140 | |

NOTES: 4. This parameter has a lower limit than BUS specification. This allows use of series resistors for current spike protection.

5. See Figure 4 (Frequency versus Capacitive Load).



PARAMETER MEASUREMENT INFORMATION



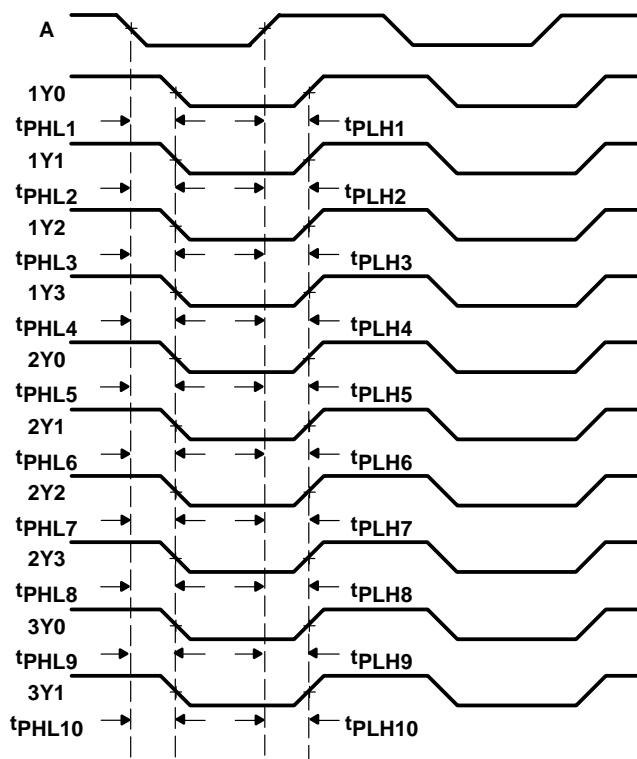
- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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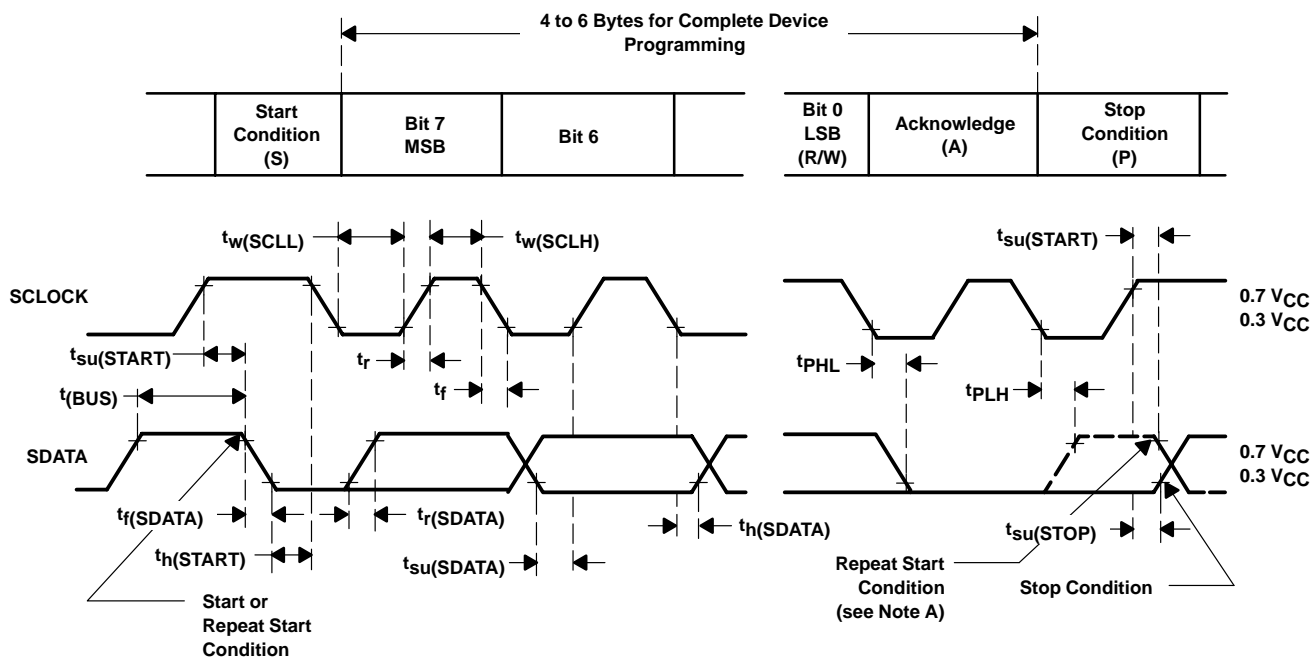
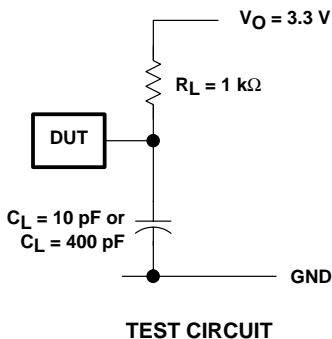
PARAMETER MEASUREMENT INFORMATION



- NOTES: A. Output skew, $t_{sk(o)}$, is calculated as the greater of:
- The difference between the fastest and slowest of t_{PLHn} ($n = 1:10$)
 - The difference between the fastest and slowest of t_{PHLn} ($n = 1:10$)
- B. Pulse skew, $t_{sk(p)}$, is calculated as the greater of $|t_{PLHn} - t_{PHLn}|$ ($n = 1:10$).
- C. Process skew, $t_{sk(pr)}$, is calculated as the greater of:
- The difference between the fastest and slowest of t_{PLHn} ($n = 1:10$) across multiple devices under identical operating conditions
 - The difference between the fastest and slowest of t_{PHLn} ($n = 1:10$) across multiple devices under identical operating conditions

Figure 2. Waveforms for Calculation of $t_{sk(o)}$, $t_{sk(p)}$, $t_{sk(pr)}$

PARAMETER MEASUREMENT INFORMATION



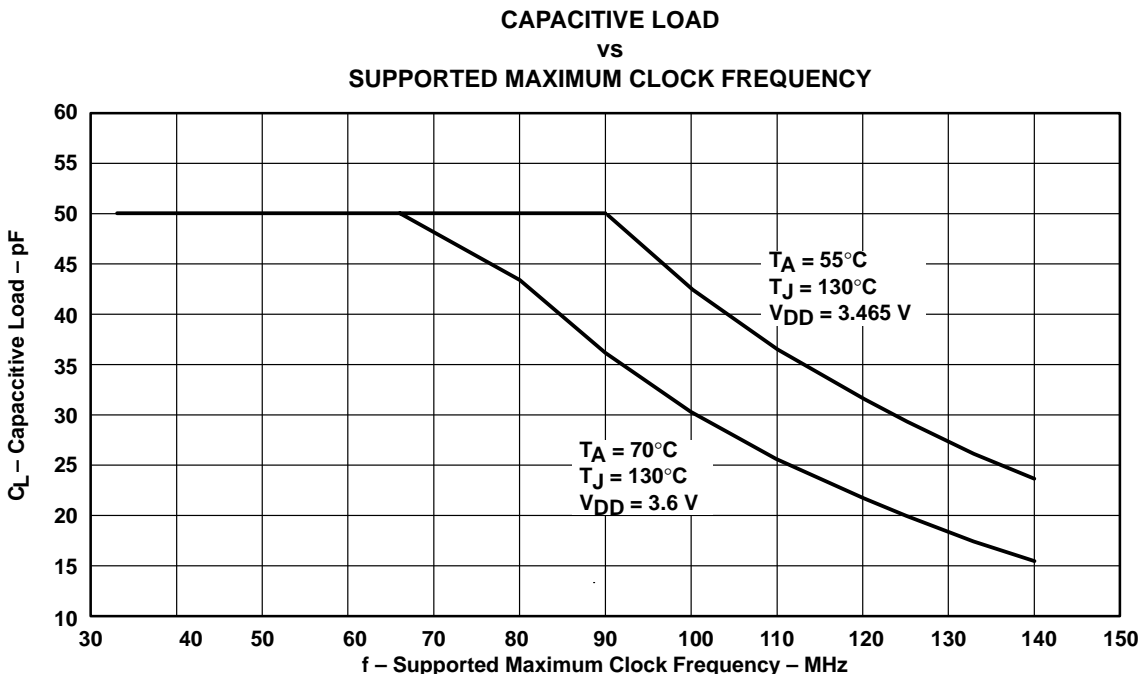
| BYTE | DESCRIPTION |
|------|-----------------------------------|
| 1 | I ² C address |
| 2 | Command (dummy value, ignored) |
| 3 | Byte count (dummy value, ignored) |
| 4 | I ² C data byte 0 |
| 5 | I ² C data byte 1 |
| 6 | I ² C data byte 2 |

NOTES: A. The repeat start condition is not supported.
 B. All input pulses are supplied by generators having the following characteristics: PRR ≤ 100 kHz, Z_O = 50 Ω, t_r ≥ 10 ns, t_f ≥ 10 ns.

Figure 3. Propagation Delay Times, t_r and t_f

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NOTES: A. With a total capacitive load of 20 pF for each output, the CDC319 is capable of running up to about 125 MHz. A lower capacitive load will allow higher application frequencies, up to 133 MHz (140 MHz).

B. CPD for the CDC319 is about 25 pF per output (21 pF if $C_L < 20$ pF)
 $P(\text{total}) = V_{DD}^2 \times CPD \times F_O \times N + (V_{OH} - V_{OL})^2 \times C_L \times F_O \times N + \text{DC load}$

where:

N = number of switching outputs

F_O = clock frequency

Package thermal impedance (junction-to-ambient) = 92.4°C/W

Maximum junction temperature = 150°C (<125°C recommended)

Figure 4

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|---------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| CDC319DB | Active | Production | SSOP (DB) 28 | 50 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | CDC319 |
| CDC319DB.B | Active | Production | SSOP (DB) 28 | 50 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | CDC319 |
| CDC319DBR | Active | Production | SSOP (DB) 28 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | CDC319 |
| CDC319DBR.B | Active | Production | SSOP (DB) 28 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | CDC319 |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CDC319DBR | SSOP | DB | 28 | 2000 | 330.0 | 16.4 | 8.45 | 10.55 | 2.5 | 12.0 | 16.2 | Q1 |

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-----------|--------------|-----------------|------|------|-------------|------------|-------------|
| CDC319DBR | SSOP | DB | 28 | 2000 | 353.0 | 353.0 | 32.0 |

TUBE


*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| CDC319DB | DB | SSOP | 28 | 50 | 530 | 10.5 | 4000 | 4.1 |
| CDC319DB.B | DB | SSOP | 28 | 50 | 530 | 10.5 | 4000 | 4.1 |

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